

Electronic Acknowledgement Receipt

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Application Number:	10596387
International Application Number:	
Confirmation Number:	5987
Title of Invention:	Epoxy Resin Molding Material for Sealing and Electronic Component
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Application Type:	U.S. National Stage under 35 USC 371

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement Letter	08-05-15_IDS_with_cert.pdf	71459 d502ce23715f1984284351d2bfeca3e0923c2177	no	3

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2	Information Disclosure Statement (IDS) Filed	08-05-15_US_IDS_Form__S B_08a.pdf	660337	no	4
			1012d6a1ffd1db79b4968045359a9eee62aed85		

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3	NPL Documents	08-05-15_NPL01_Office_acti on.pdf	485677	no	10
			52909c6df10d282a717860aac1faec4e363b3679		

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National Stage of an International Application under 35 U.S.C. 371

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New International Application Filed with the USPTO as a Receiving Office

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